

2827

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Salman Akram	§	Group Art Unit:	2827
Serial No.:	09/853,111	§		
Filed:	May 10, 2001	§	Examiner:	A. Chambliss
For:	Method of Fabricating Mounted Multiple Semiconductor Dies In A Package (As Amended)	§	Atty. Dkt. No.:	MCT.0012D1US (97-0141)

Commissioner for Patents  
Washington DC 20231

REPLY TO PAPER NO. 11

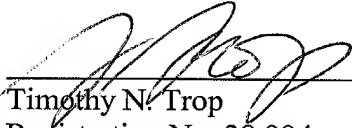
Sir:

In response to the notice of informal amendment mailed February 26, 2003, the undersigned discussed the response format with the Examiner on March 5, 2003. Apparently the present case is part of the E Phoenix program and, therefore, the new amendment format applies. Therefore, it is understood that the Examiner agrees that the amendment is in the required format and that the notice of informal response will be withdrawn.

RECEIVED  
MAR 11 2003  
TECHNOLOGY CENTER 8800

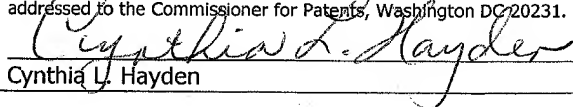
Respectfully submitted,

Date: March 6, 2003

  
Timothy N. Trop  
Registration No. 28,994  
TROP, PRUNER & HU, P.C.  
8554 Katy Freeway, Suite 100  
Houston, Texas 77024  
(713) 468-8880 [Phone]  
(713) 468-8883 [Fax]

Date of Deposit: March 6, 2003

I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, Washington DC 20231.

  
Cynthia L. Hayden